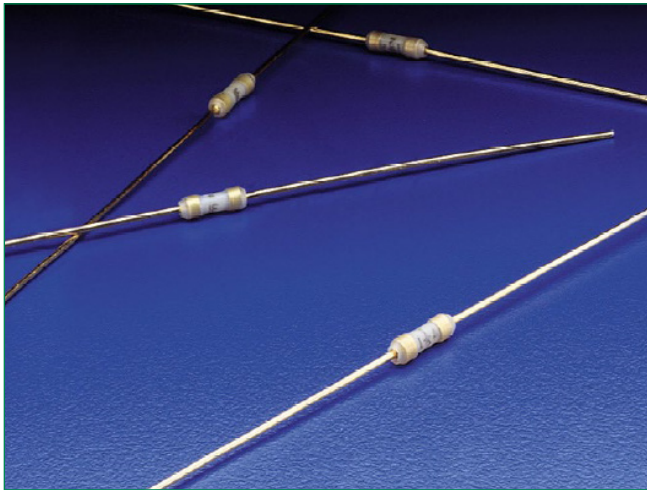


275 Series, PICO® Very Fast-Acting Fuse



Description

The PICO® Very Fast-Acting Fuse is designed to meet an extensive array of performance characteristics in a space-saving subminiature package.


Features

- Very fast-acting
- Small size
- High current rating (20A- 30A)
- RoHS compliant
- Wide operating temperature range
- Low temperature derating

Applications

- Power supply
- Networking equipment
- PC server
- Storage system

Agency Approvals

| Agency | Agency File Number | Ampere Range |
|---|--------------------|--------------|
|  | E10480 | 20A - 30A |

Additional Information



Datasheet



Resources




Samples

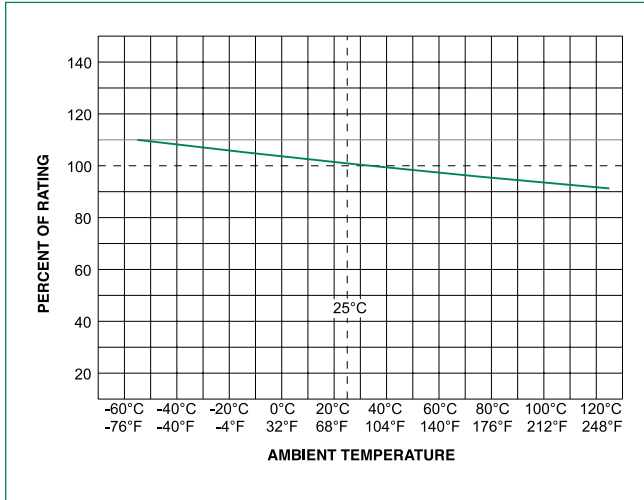
Electrical Characteristics

| % of Ampere Rating | Ampere Rating | Opening Time |
|--------------------|---------------|------------------|
| 100% | 20A - 30A | 4 Hours, Min. |
| 200% | 20A - 30A | 10 Seconds, Max. |

Electrical Characteristics

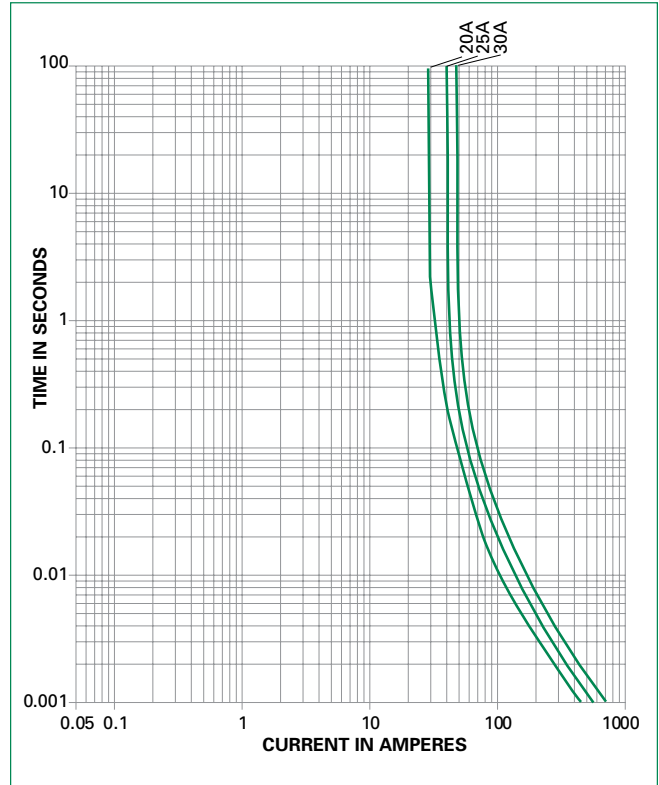
| Ampere Rating (A) | Amp Code | Ordering Number | Max Voltage Rating (V) | Interrupting Rating | Nominal Cold Resistance (Ohms) | Nominal Melting I ² t (A ² sec) | Agency Approvals  |
|-------------------|----------|-----------------|------------------------|--------------------------|--------------------------------|---|--|
| 20.0 | 020. | 0275020. | 32 | 300A@32VDC 100A@32VAC | 0.0033 | 203 | x |
| 25.0 | 025. | 0275025. | 32 | | 0.0024 | 288 | x |
| 30.0 | 030. | 0275030. | 32 | | 0.0020 | 355 | x |

Temperature Re-rating Curve



Note: Re-rating depicted in this curve is in addition to the standard derating of 25% for continuous operation.

Average Time Current Curves



Soldering Parameters

Recommended Process Parameters:

| Wave Parameter | Lead-Free Recommendation |
|---|-----------------------------------|
| Preheat: (Depends on Flux Activation Temperature) | (Typical Industry Recommendation) |
| Temperature Minimum: | 100°C |
| Temperature Maximum: | 150°C |
| Preheat Time: | 60-180 seconds |
| Solder Pot Temperature: | 260°C Maximum |
| Solder Dwell Time: | 2-5 seconds |

Recommended Hand-Solder Parameters:

Solder Iron Temperature: 350°C +/- 5°C
Heating Time: 5 seconds max.

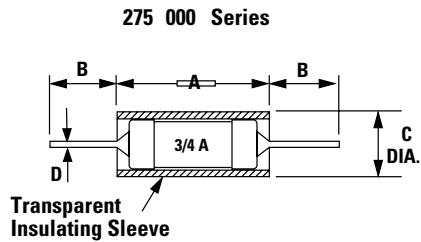
Note: These devices are not recommended for IR or Convection Reflow process.

Product Characteristics

| | |
|------------------------|--|
| Materials | Transparent Polyvinylidene Fluoride sleeve covered body, pure tin plated copper wire leads |
| Solderability | MIL-STD-202, Method 208 |
| Lead Pull Force | MIL-STD-202, Method 211, Test Condition A (will withstand a 5lbs. axial pull test) |

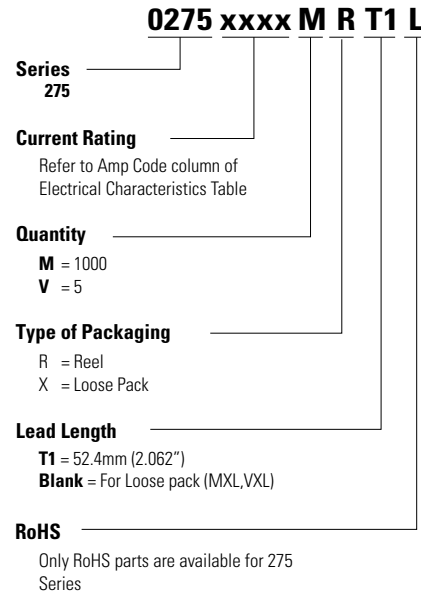
| | |
|------------------------------|--|
| Operating Temperature | -60°C to +125°C (Consider re-rating) |
| Shock | MIL-STD-202, Method 213, Test Condition I (100 G's peak for 6 milliseconds) and per method 2028 (78G's peak for 11 milliseconds) |
| Vibration | MIL-STD-202, Method 201 (10-55 Hz); Method 204, Test Condition D (Vibrations of 10-2000 cps at 20 G's) |
| Moisture Resistance | MIL-STD-202, Method 106 |

Dimensions



| Amperage | Dimensions in mm (inches) | | | |
|----------|---------------------------|-------------------|-----------------|------------------|
| | A | B | C | D |
| 20 - 30 | 7.87 (.31") | 27.78 (1.094") | 3.38 (.133") | 1.016 (.040") |

Part Numbering System



Packaging

| Packaging Option | Packaging Specification | Quantity & Packaging Code |
|-----------------------------------|-------------------------|---|
| T1: 52.4mm (2.062") Tape and Reel | EIA 296 | Please refer to available quantities above in "Part Numbering System" |

The default lead length for loose pack is T1.